



SS 3150BF THRU SS 3200BF

VOLTAGE RANGE
CURRENT150 to 200 Volts
3.0 Ampere

Features

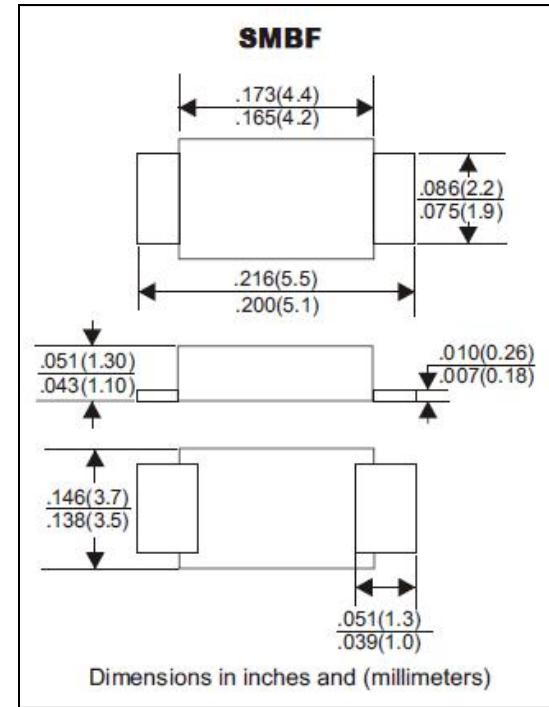
- The plastic package carries Underwriters Laboratory Flammability Classification 94V - 0
- For surface mounted applications
- Metal silicon junction, majority carrier conduction
- Low power loss, high efficiency
- Built-in strain relief, ideal for automated placement
- High forward surge current capability
- High temperature soldering guaranteed: 260 C/10 seconds at terminals

Mechanical Data

- Case: Transfer molded plastic
- Epoxy: UL 94V - 0 rate flame retardant
- Lead: Solder plated, solderable per MIL - STD - 750 method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.002 ounce, 0.066 gram

Maximum Ratings and Electrical Characteristics

- Ratings at 25°C ambient temperature unless otherwise specified
- Single phase, half wave, 60Hz, resistive or inductive load
- For capacitive load derate current by 20%



TYPE NUMBER	SYMBOLS	SS3150BF	SS3200BF	UNIT
Device Marking Code		SS315	SS320	
Maximum Repetitive Peak Reverse Voltage	V _{RRM}	150	200	Volts
Maximum RMS Voltage	V _{RMS}	105	140	Volts
Maximum DC Blocking Voltage	V _{DC}	150	200	Volts
Maximum Average Forward Rectified Current at T _{case} see figure 1 T _L = 75 °C	I _(AV)	3.0		Amps
Peak Forward Surge Current 8.3 ms single half sine - wave superimposed on rated load (JEDEC method)	I _{FSM}	80		Amps
Maximum Instantaneous Forward Voltage @ 3.0 A ^(Note 1)	V _F	0.95		Volts
Maximum DC Reverse Current at rated DC Blocking Voltage per element	I _R	0.1		mA
		10		
Typical Thermal Resistance ^(Note 2)	R _{θJA}	90		°C/W
	R _{θJL}	9		
Diode junction capacitance ^(Note 3)	C _J	110		pF
Operating Junction Temperature	T _J	-40 to +150		°C
Storage Temperature Range	T _{STG}	-40 to +150		°C

Notes:

1. Pulse test: 300µs pulse width, 1% duty cycle.
2. Thermal resistance from Junction to ambient and from junction to lead mounted on PCB. with 0.3 × 0.3 "(8.0 × 8.0mm)copper pad areas.
3. f = 1MHz and applied 4V DC reverse voltage.



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Fig. 1 - Forward Current Derating Curve

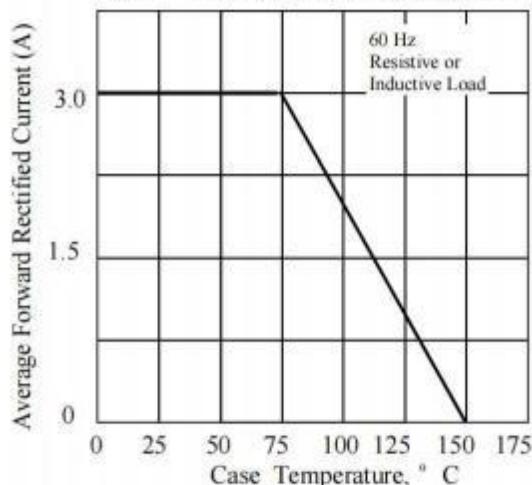


Fig 3. - Typical Instantaneous Forward Characteristics

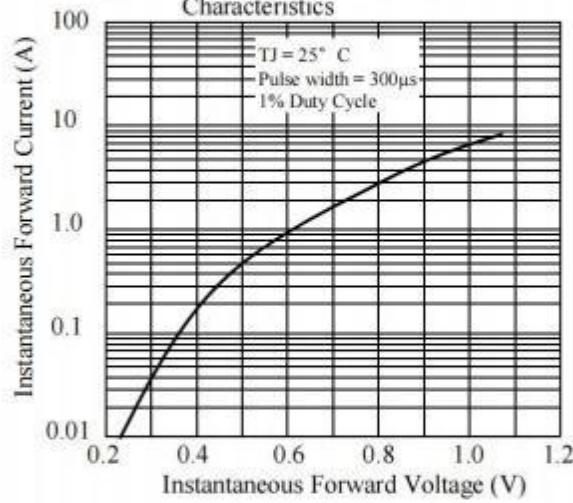


Fig 5. - typical transient thermal impedance

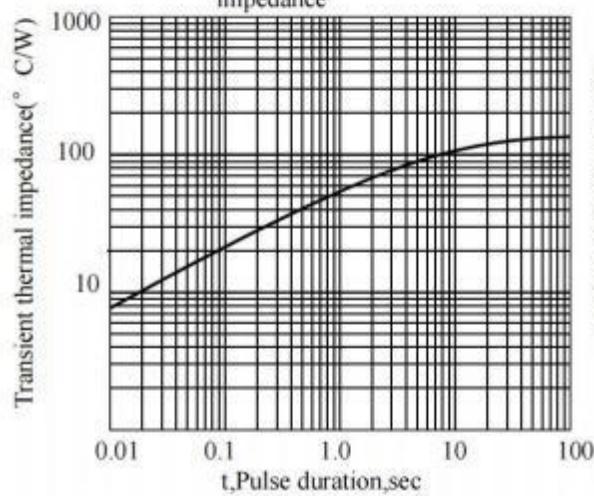


Fig. 2 - Maximum Non-repetitive Peak Forward Surge Current

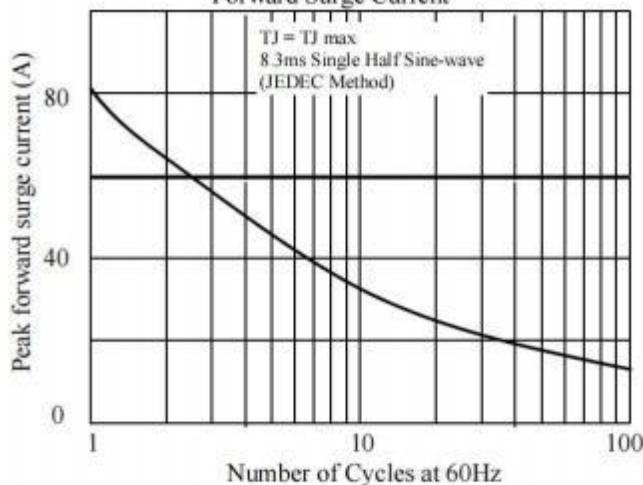


Fig 4. - Typical Reverse Characteristics

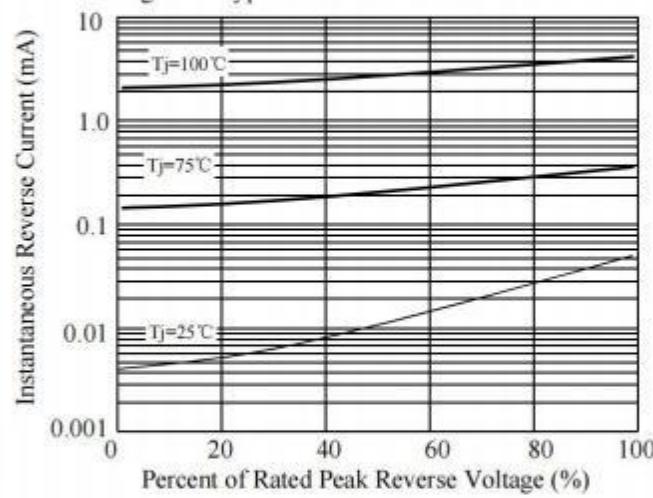
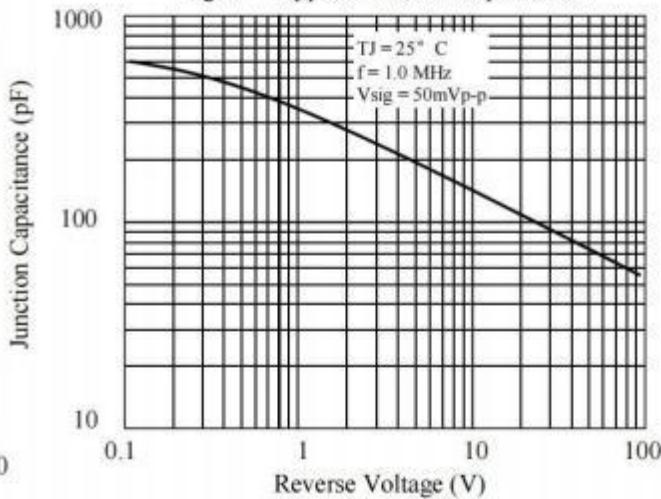


Fig 6. - Typical Junction Capacitance

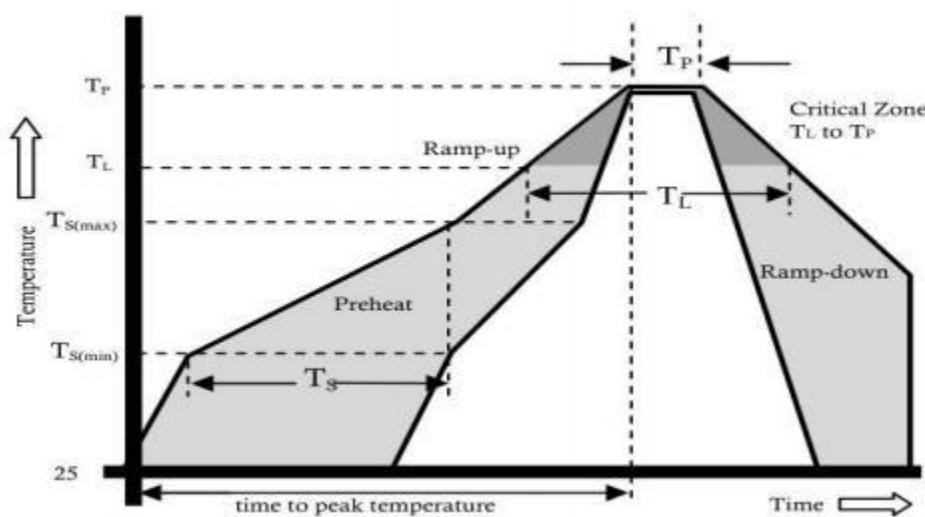




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Reflow Profile



Reflow Condition		Pb - Free Assembly
Pre Heat	Temperature Min.	+150°C
	Temperature Max.	+200°C
	Time(Min to Max)	60 -180 secs.
Average ramp up rate(Liquidus Temp(TL) to peak)		3°C/sec. Max.
Ts(max) to TL - Ramp - up Rate		3°C/sec. Max.
Reflow	Temperature (TL)(Liquidus)	+217°C
	Temperature (TL)	60 -150 secs.
Peak Temp (TP)		+(260+0/ -5) °C
Time within 5°C of actual Peak Temp (TP)		25 secs.
Ramp - down Rate		6°C/sec. Max.
Time 25°C to peak Temp (TP)		8 min. Max.
Do not exceed		+260°C